# axcelis

# **INVESTOR EVENT**

July 2024\*



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Purion

FORWARD LOOKING STATEMENT CAUTION Statements in this presentation other than historical facts, such as statements pertaining to: (i) future industry demand for semiconductors and WFE; (ii) future development of regulatory landscape; (iii) our market position for the future; (iv) our forecast of financial measures for the following quarter and full year; (v) our long-term financial targets and underlying assumptions; (vi) our future investment plan on R&D, technology and infrastructure; and (vii) future shareholder returns, are forward-looking statements and subject to the Safe Harbor provisions created by the Private Securities Litigation Reform Act of 1995.

These forward-looking statements are based on current information and expectations and involve a number of risks and uncertainties. Actual results may differ materially from those projected in such statements due to various factors, including but not limited to: economic, political and social conditions in the countries in which we, our customers and our suppliers operate; disruption to our manufacturing facilities or other operations, or the operations of our customers, due to natural catastrophic events, health epidemics or terrorism; ongoing changes in the technology industry, and the semiconductor industry in particular, including future growth rates, pricing trends in end-markets, or changes in customer capital spending patterns; our ability to timely develop new technologies and products that successfully anticipate or address changes in the semiconductor industry; our ability to maintain our technology advantage and protect our proprietary rights; our ability to compete with new products introduced by our competitors; our ability or the ability of our customers to obtain U.S. export control licenses for the sale of certain products or provision of certain services to customers in China.

For other factors that may cause actual results to differ materially from those projected and anticipated in forwardlooking statements in this material, please refer to Axcelis' most recent Annual Report on Form 10-K, and other subsequent filings with the Securities and Exchange Commission. Axcelis assumes no obligation to, and does not currently intend to, update these forward-looking statements

# PRESENTERS









Russell Low, PhD President & CEO Overview, Strategy

# **Greg Redinbo, PhD** EVP, Marketing & Applications Products and R&D

James Coogan EVP & CFO Financials Doug Lawson EVP, Marketing & Strategy Moderator



# Axcelis Well Positioned Across Multiple Market Inflections

Russell Low, PhD

President & CEO



# **INVESTMENT CASE SUMMARY**



Foundational Technology for Semiconductor Manufacturing Well Positioned for Market Inflections & Secular Growth Opportunities

Long-Term Margin Expansion & Earnings Growth Strong Balance Sheet with Balanced Capital Allocation

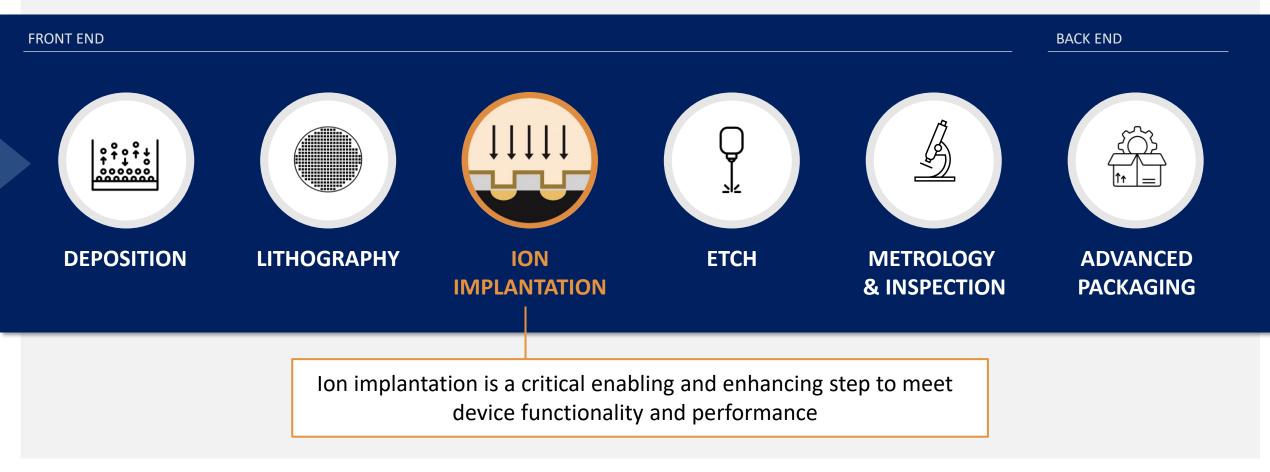


Our highly proprietary ion implantation tools provide a critical step in semiconductor production, enabling multiple emerging technologies.



# WHERE WE FIT IN THE INDUSTRY

# **Fundamental Steps in Semiconductor Production**



# WHAT IS AN ION IMPLANTER?

#### WHAT

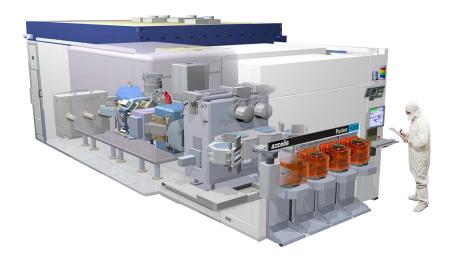
Ion implantation is the process of delivering materials into semiconductors to locally change its properties

### WHY

To modify the electrical or physical characteristics of a material to determine device performance

#### HOW

Precisely delivering ions of high purity at the right dose, energy and angle





# WHAT IS PURION?

A common ion implant platform consisting of modern toolsets that enable cutting edge device design and production while meeting the growing needs for today's most sophisticated devices

From mature process nodes implant to advanced logic material modification, Purion optimizes our customers need for:

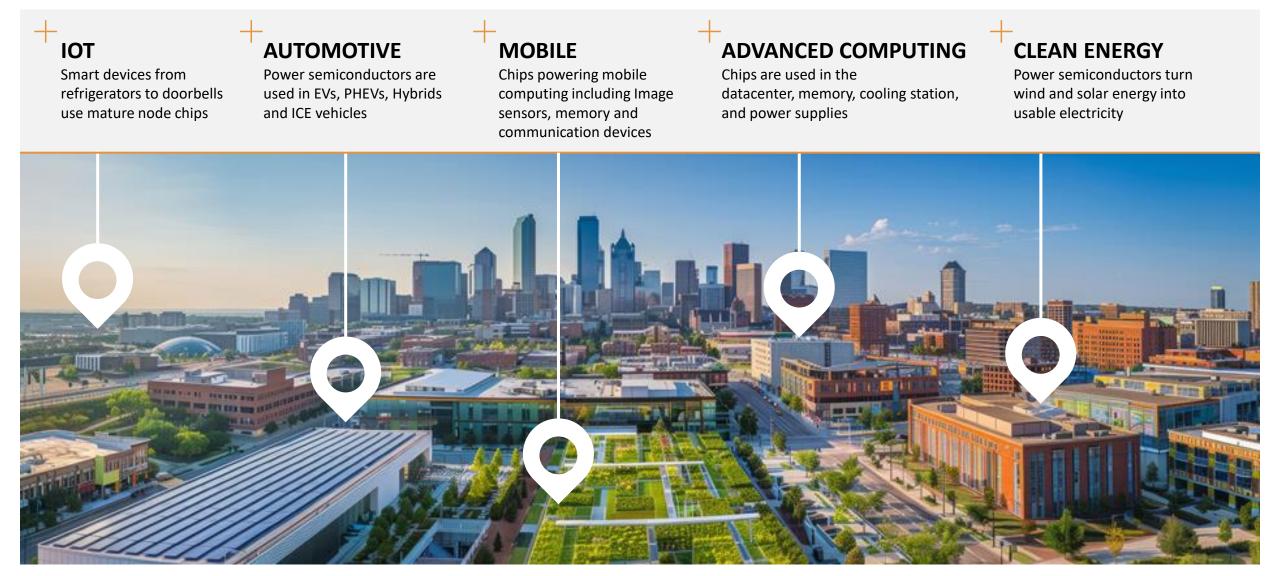
+ PURITY + PRODUCTIVITY

+ PRECISION

+ COST OF OWNERSHIP



# OUR PRODUCTS ARE USED IN A GROWING VARIETY OF APPLICATIONS



# GROWTH

Multiple initiatives will accelerate Purion across all markets

### Power Devices: Continued Focus On The Growing Market Opportunity

New customers and growing footprint with existing customers as they ramp to high volume manufacturing



### Geographic Expansion

China: Emphasis on mature process technology for a large, diverse group of customers

Japan: Focus on power devices, image sensors and NAND



### Purion Footprint Growth at Our Existing Customer Base

Adding Purion product types including Advanced Logic Capabilities

Targeted joint developments around improved device performance and higher productivity



### New Implant Applications

Collaborating with customers and industry peers to develop novel uses for ion implant



# **POWER MARKET DRIVERS**

# ↓ GREENHOUSE GAS EMISSIONS







# AI – ENERGY USE

### 7.3 TWh

Estimated annual energy consumption for the 100,000 NVIDIA units shipped in 2023.

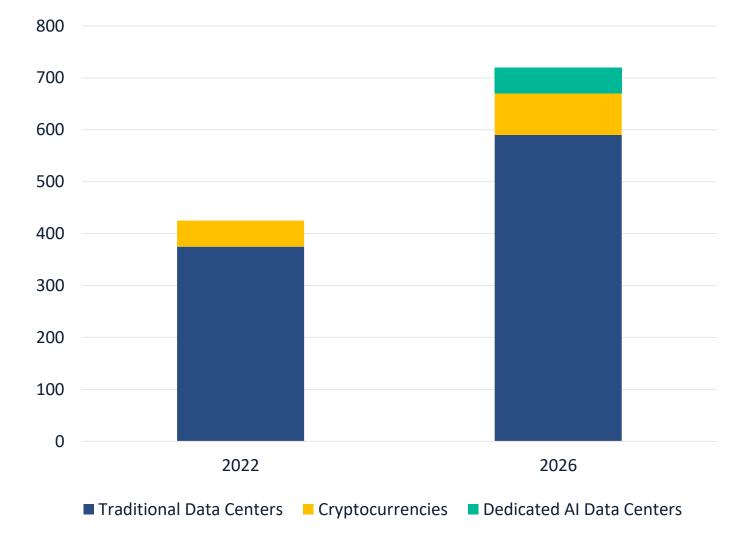
### **10X**

Estimated increase in energy consumption from AI by 2026

The US Department of Energy (DOE) is supporting the local production of semiconductors and is funding the development of **more efficient semiconductors** over the next two decades. More efficient semiconductors reduce cooling requirements, thus supporting the decarbonization of the sector.

Chinese regulators will require all data centers acquired by public organizations to improve their energy efficiency and be entirely powered by renewable energy by 2032, starting with a 5% share mandate for renewables in 2023.

#### **Estimated Electricity Demand**



Data center electricity demand excludes consumption from data network centers.

TWh

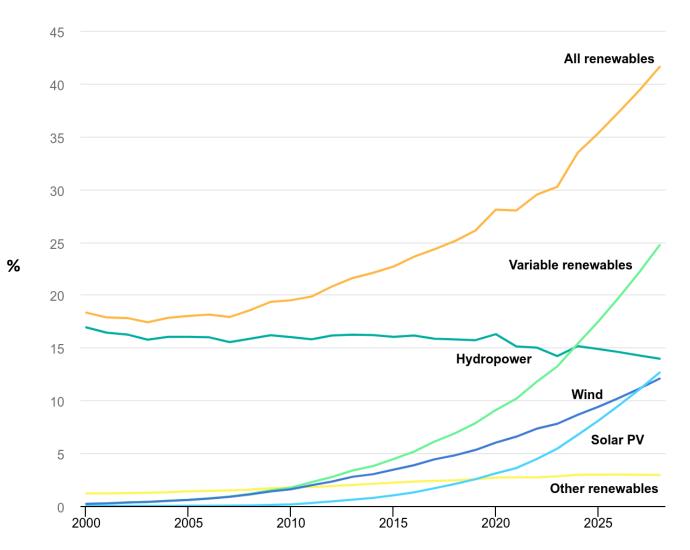
# CLEAN ENERGY

Approximately 3,700 GW of new renewable capacity will come online globally over the 2023-2028 period

Over the coming five years, several global renewable energy milestones are expected to be achieved:

- In 2024, **wind and solar PV** together generate more electricity than hydropower.
- In 2025, **renewables** surpass coal to become the largest source of electricity generation.
- Wind and solar PV each **surpass nuclear** electricity generation in 2025 and 2026 respectively.
- In 2028, **renewable** energy sources account for over 42% of global electricity generation.

### Transformation of the Global Power Mix (2000-2028)

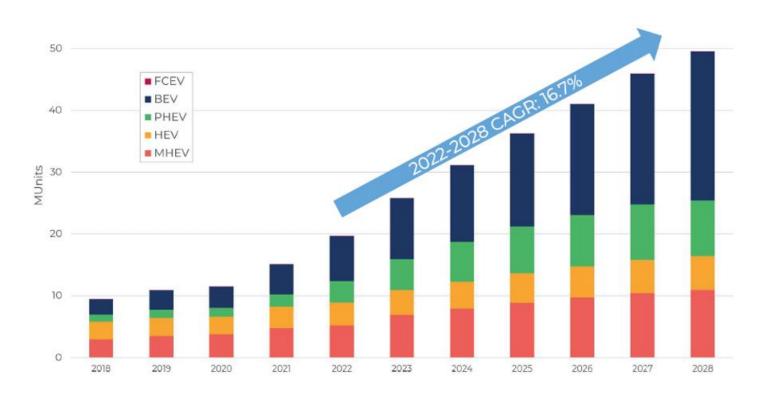


# AUTOMOTIVE ELECTRIFICATION

Globally passenger car electrification continues to grow with BEV, PHEV, and HEV

- Battery electric vehicles is the biggest market in units and value.
- Electric car sales exceeded 10 million in 2022 and accounted for close to 15% of the global car market.
- China continues to dominate the market, representing around 60% of all electric cars sold globally.

#### xEV Market in Unit, Split By Vehicle Electrification Type

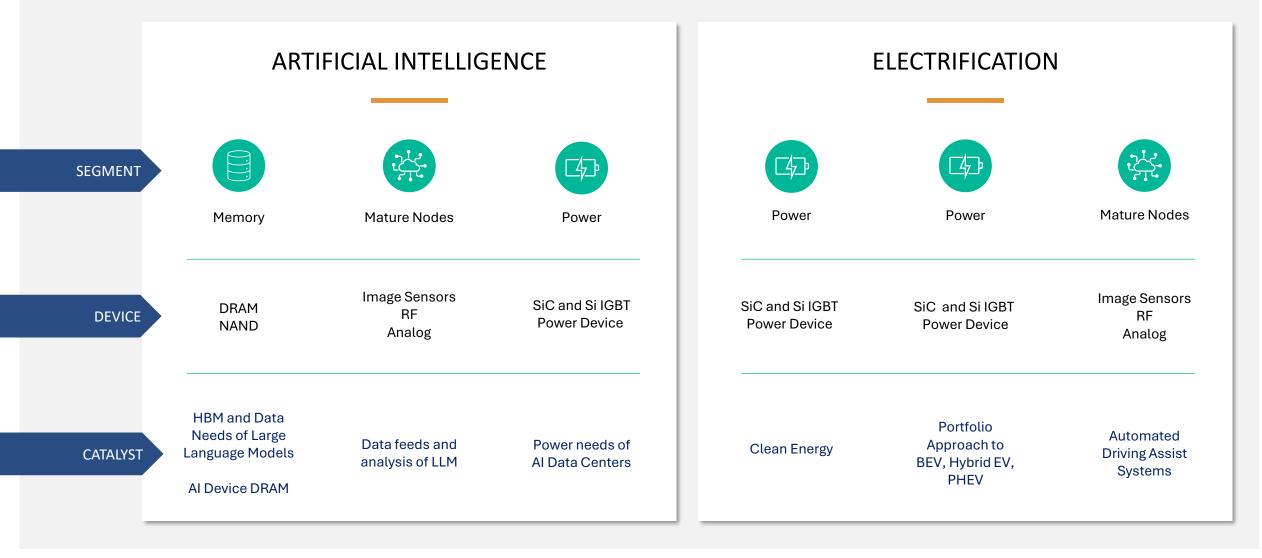


FCEV: Fuel Cell Electric Vehicle BEV: Battery Electric Vehicle HEV: Hybrid Electric Vehicle MHEV: Mild Hybrid Electric Vehicle PHEV: Plug-in Hybrid Electric Vehicle

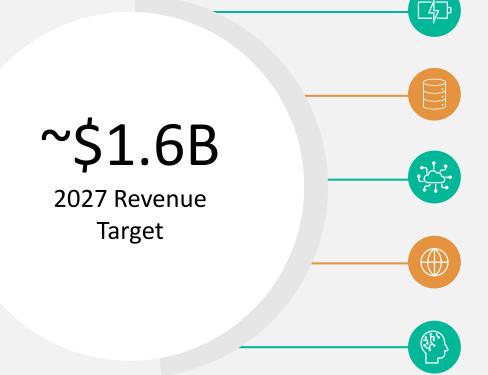
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#### Global EV Data Explorer - Data Tools - IEA

# MARKET OPPORTUNITIES DRIVING NEAR-TERM GROWTH



# MULTIPLE INPUTS TO LONG-TERM GROWTH



### Power

All battery powered devices require Si and SiC semiconductors. SiC is used to create high performance power devices serving technologies such as EVs, PHEVs, Charging, Solar, Wind and Energy Storage

#### Memory

Storage and processing devices, DRAM and NAND, serving PC, Mobile and Datacenters driven by AI and technology refresh cycles

#### **Mature Nodes**

Al driven demand, IOT, Image Sensors, and general automotive to drive greater connectivity of devices utilizing mature node technology

#### **Geographic Expansion**

Increased exposure in new strategic markets

### **Advanced Logic**

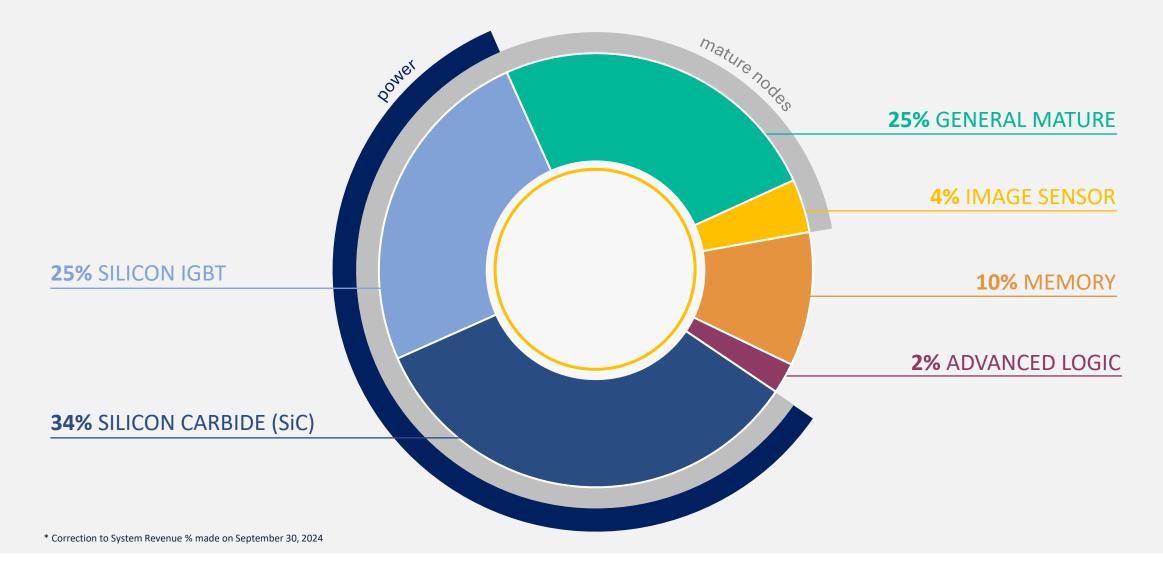
Strategic investments and evaluation units in Advanced Logic to drive longer-term growth

# Market Drivers and Positioning for Future Growth

Greg Redinbo, PhD EVP, Marketing & Applications



# REVENUE BY SEGMENT – 2023 SYSTEMS REVENUE OF \$884M



# ION IMPLANT TAM HAS MORE THAN DOUBLED AND CONTINUES TO GROW

### **70%**

Approximate make up of implant TAM from Mature Process Technology market segments

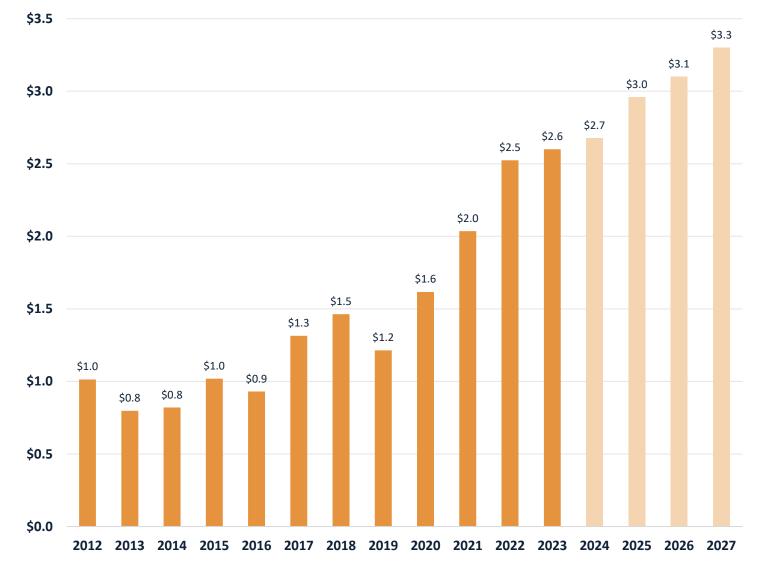
Strong TAM growth driven by:

- Increased wafer starts across all segments
- Rapid growth of implant intensive mature nodes, power and image sensor devices

Axcelis Opportunity:

- High value Purion product extensions required by specialty markets
- Purion Power and Image Sensor Series

#### ION IMPLANT ANNUAL TAM ESTIMATES (\$B)





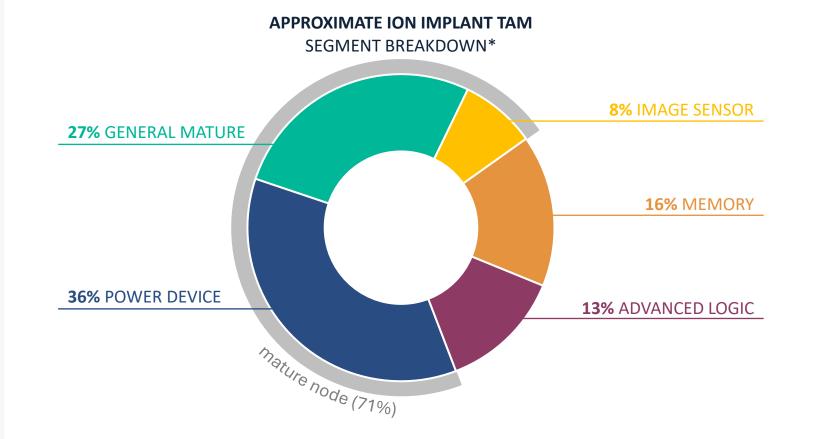
# ION IMPLANT TAM SEGMENT BREAKDOWN

### Mature Process Technology Segment is Driving Ion Implant TAM Growth

The mature process technology segment accounts for approximately 70% of the ion implant TAM

- Mature process technology is growing based on increases in wafer starts, high implant capital intensity, and higher value implanters for specialty devices
- Memory expected to be driven by new wafer start activity to support bit growth demand
- Advanced logic has increased based on accelerating wafer start growth

Implant TAM for SiC devices is expected to grow within the power device segment, driven by end market growth, device performance enhancements, and fab optimization efforts



# ENABLING OUR CUSTOMERS' PRODUCTS



# GROWTH ROADMAP ALIGNED WITH MARKET SEGMENT OPPORTUNITIES

MARKET SEGMENT	DEVICES PRODUCED	CAPITAL INTENSITY	EST. PERCENT OF IMPLANT CAPEX*	LEADING CHIPMAKERS	
MEMORY Per 100K WSPM	NAND	~30 - 40 Total Implanters		Samsung SK Hynix Micron Kioxia	
	DRAM	~45 - 55 Total Implanters	16%		
MATURE PROCESS TECHNOLOGY ex Power <u>&gt;</u> 28NM	Image Sensors MEMS Comms Analog uController	<ul> <li>300mm/200mm/150mm</li> <li>Power Devices and HE in Image Sensor</li> <li>Purion H, M and XE</li> </ul>	35%	TSMC GlobalFoundries Sony TI Infineon	
POWER DEVICE Per 100K WSPM	Power	~50 - 70 Total Implanters	36%	ST UNT BYD Wolfspeed OnSemi Rohm	
ADVANCED LOGIC (FinFET/GAA) Per 100K WSPM	CPU SOC Graphics Comms	~30 - 40 Total Implanters	13%	Intel TSMC Samsung	

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#### SIGNIFICANT GROWTH IN POWER

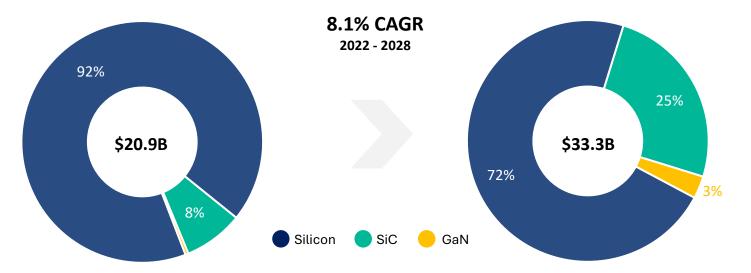
# POWER BREAKDOWN

**25% CAGR IN SIC POWER** DEVICE GROWTH 2023 to 2029

The SiC device market is expected to reach more than \$10B by 2029, at a CAGR (23-29) of 25%.

Automotive and mobility will account for more than 80% of the total SiC market

Battery Electric Vehicle will remain the main market driver for SiC



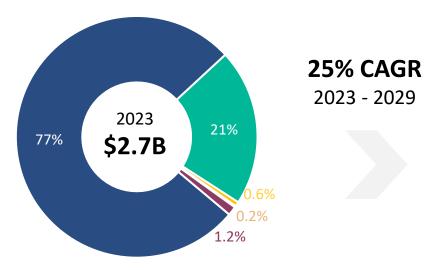
#### POWER END MARKET OVERVIEW CAGR 2022 - 2028

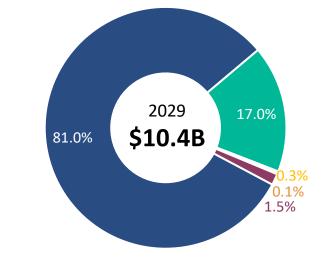
Automotive & Mobility	12.9%
Industrial	7.1%
Medical	4.7%
Telecom & Infrastructure	4.2%
Mobile & Consumer	0.3%
TOTAL	8.1%

# SILICON CARBIDE MARKET FORECAST

The SiC Device process requires significant investment in epitaxy equipment, ion implanters, metrology and inspection tools.

SiC WFE excluding PVT	CAGR '23-'29
Thinning and CMP	0.1%
Deposition	-0.2%
Epitaxy/HTCVD	6.4%
Thermal Processing	4.7%
Etch and clean	6.1%
Ion Implantation	9.7%
Patterning	-0.3%
Metrology and inspection	11.1%
Wafer Bonding	9.9%
Total SiC Equipment	6.5%





#### INDUSTRIAL

UPS Motor Drives Industrial Power Supply LIDAR DC Charging Station Wind Photovoltaics

#### **AUTOMOTIVE & MOBILITY**

EV/HV LIDAR in Autonomous Vehicles E-Bikes E-Motorcycles Train

#### **TELECOM & INFRASTRUCTURE**

Data Centers Servers Base Stations

#### **MOBILE & CONSUMER**

Home Appliances Mobile Fast Charging Wireless Charging Audio and Image

#### OTHERS

Defense Aerospace Medical

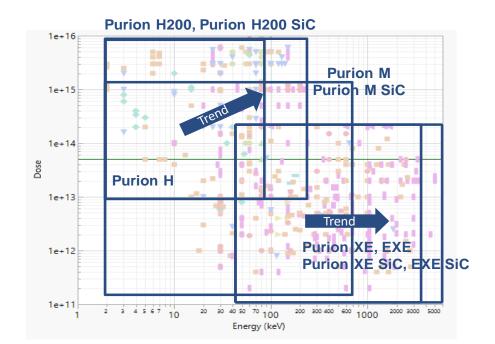
#### POWER DEVICE RECIPE REQUIREMENTS

# AXCELIS IS THE POWER LEADER

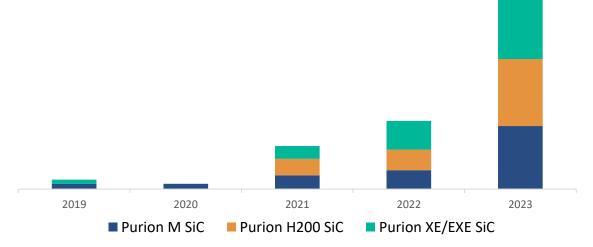
First Mover Advantage - Axcelis has been a leader in SiC implant since 2014, creating a significant incumbency advantage

Purion Power Series:

- A portfolio of HE, MC, HC and the tools serving the full range of our customers' needs
- Production-proven
- Flexible
- Extendible meeting needs of trench and superjunction MOSFETS
- Upgradeable to meet the transition from 150mm to 200mm











### Full Product Offering in country servicing available market segments

> \$450M APPROXIMATE MARKET SIZE < **10%** CURRENT MARKET PENETRATION

# LOCAL

In country resources serving the market

## PARTNERSHIP

Working with leading device manufacturers to evaluate technology and products

# **PRODUCT STRENGTH**

Winning applications over local competition in the Power market given the strength of our Purion Power Series

Segments Targeted:



POWER DEVICE



IMAGE SENSOR



MEMORY



ADVANCED LOGIC



# ADVANCED LOGIC

Grows with direct correlation to wafer starts and technology shrinks associated with advanced device manufacturing.

> \$400M APPROXIMATE MARKET SIZE

< 5%

CURRENT MARKET PENETRATION

## PRODUCT

Purion Dragon is a leading-edge tool focused on meeting the needs of Advanced Logic customers

# **INVESTMENT**

Developing extensions, product upgrades, and refinements for the unique requirements of advanced logic devices

# CONTRIBUTION

Timing for more meaningful contribution is 3-5 years



### **CURRENT EFFORTS**

### LEARNER Development System with Leading European Advanced Logic Research

Institute

### EARNER

Evaluation System with Customer Advanced R&D Center

PRODUCTION High Current systems with high volume advanced logic production lines

# PURION – THE CORE OF OUR GROWTH STRATEGY

Purion products targeted at high value applications and market segments



TARGETED MARKET SEGMENTS

# NEW PRODUCT DEVELOPMENT DRIVING SALES GROWTH

	CUSTON CHALLEN		NEXT-GEN SOLUTIONS	HIGH VALUE OPPORTUNITY
POWER DEVIC	E – Si IGBT Back Implar	None	Purion VXE Platform	Systems Sales
POWER DEVIC	E – SiC E – SiC E – SiC	ments, Incing Purion Power Se	eries Purion Power Extensions	Systems Sales Upgrades
ADVANCED LC	GIC for Advance Device	d Logic Purion H	Purion Dragon	Systems Sales
POWER AND A	DVANCED LOGIC Cost of Owr	nership Chained Impla	nts MUSIC	System Extension Upgrades



# POWER DEVICE SOLUTIONS | SI IGBT BACKSIDE IMPLANT

### **CUSTOMER CHALLENGE** Reducing power loss during in Si IGBT power device applications

### **AXCELIS SOLUTION**

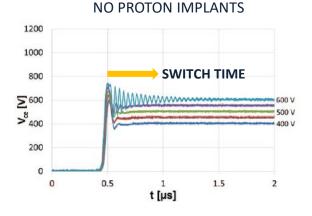
### **Optimized Purion VXE Proton Implanter**

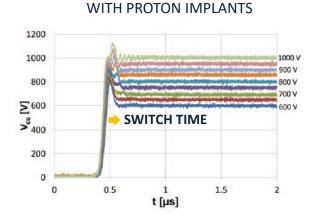
- Production-proven Purion VXE platform ( > 300 Purion High Energy installed)
- LINAC (linear accelerator) based high energy tool for higher reliability, throughput
- Optimized cooling capability for thin wafer applications

### **HIGH VALUE OPPORTUNITY**

System sales in Si IGBT application with Served Addressable Market of > \$50M

### PROTON IMPLANTS REDUCE SWITCHING TIMES FOR HIGH VOLTAGE OPERATION





#### Source: ISPSD Proceedings June 2016, Infineon

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# POWER DEVICE SOLUTIONS | PURION POWER SERIES EXTENSIONS

### **CUSTOMER CHALLENGE**

Evolving power device designs and rapid transition to new production requirements

### **AXCELIS SOLUTION**

Purion Power Series Product Extensions - Enabling Improved Device Capability

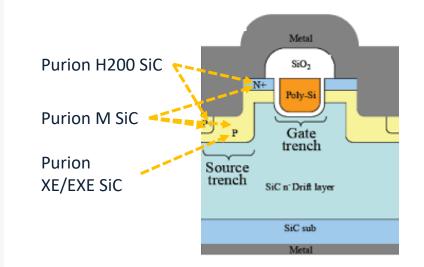
High Energy Purion EXE SiC - trench MOSFET and Superjunction devices

- Throughput increases across the platform
- New wafer heating technology
- Updated ion source technology
- Optimized cooling
- Upgrades from 150mm to 200mm wafer capability

#### **HIGH VALUE OPPORTUNITY**

Capture device transition, production fanout and upgrade from initial 150mm pilot to 200mm HVM

### SIC TRENCH MOSFET POWER DEVICE







Advanced Logic devices require more materials modification and new applications in

#### **IMPLANT STEPS**

	7nm	5nm	3nm	2nm (est.)
FEOL	24	24	26	26
MOL	4	7	7	> 10
BEOL	1	2	2	> 4

**AXCELIS SOLUTION** 

**CUSTOMER CHALLENGE** 

"middle of line" MOL process

Purion Dragon Scanned Spot Beam Technology

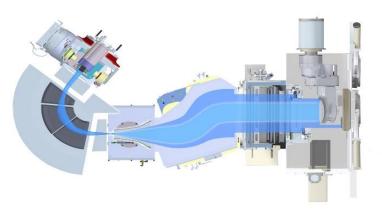
Design: Orthogonal optics enable high productivity while retaining simultaneous angle and dose control

- Productivity: > 20% demonstrated productivity advantage in low energy, high aspect ratio, critical implants
- Angle Control: Advanced vertical and horizontal angle control necessary for high aspect ratio and 3D structure implants
- Flexibility: Independent uniformity and angle control for optimizing device performance

### **HIGH VALUE OPPORTUNITY**

Incremental high current system sales for targeted applications

#### **PURION DRAGON**





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# POWER AND ADVANCED LOGIC | DEVICE PERFORMANCE AND COO

### **CUSTOMER CHALLENGE**

Customers need to create a "box" profile with uniform dopant concentration vs depth with multiple "chained" implants at lowest cost

### **AXCELIS SOLUTION**

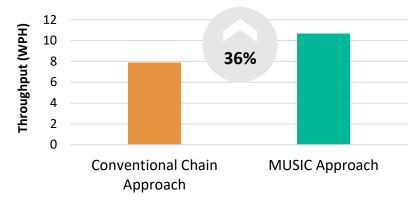
MUSIC (Multiple Steps Implant Chain)

- Unique process capability to implant multiple energy recipes in a single recipe step
- Significant throughput gain vs conventional chained implant
- Purion architectural entitlement
- IP protected

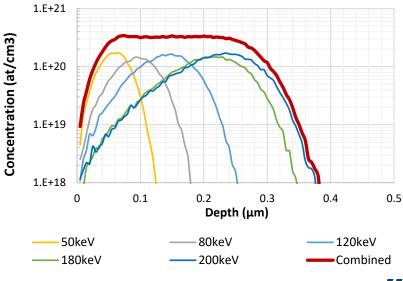
### **HIGH VALUE OPPORTUNITY**

Capture new applications in power and advanced logic









# NEW PRODUCT DEVELOPMENT DRIVING SALES GROWTH

	CUSTOMER CHALLENGE	CURRENT SOLUTION	NEXT-GEN SOLUTIONS	HIGH VALUE OPPORTUNITY
POWER DEVICE – Si	Si IGBT Backside H+ Implant	None	Purion VXE Platform	Systems Sales
POWER DEVICE – SIC	Evolving device designs and requirements, while advancing technology position	Purion Power Series	Purion Power Extensions	Systems Sales Upgrades
ADVANCED LOGIC	Targeted applications for Advanced Logic Devices	Purion H	Purion Dragon	Systems Sales
POWER AND ADVANCED LOGIC	Cost of Ownership	Chained Implants	MUSIC	System Extension Upgrades

# Continued Financial Strength Underpinning Long Term Value Creation

James Coogan EVP & CFO



# HISTORICAL FINANCIAL SUMMARY

### **REVENUE GROWTH DRIVERS:**

Broad success in Silicon Carbide and Silicon IGBT

Strong demand backdrop for memory

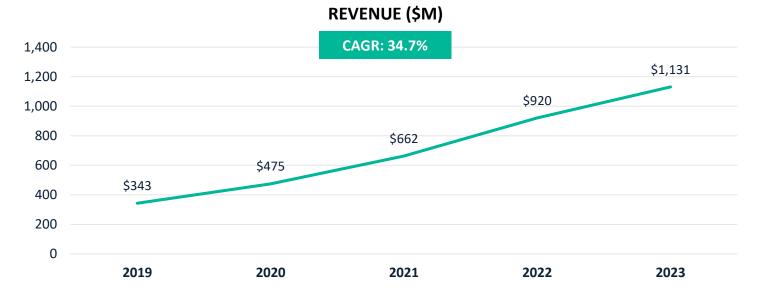
Continued support in mature nodes driven by expanding global chip demand for connected devices

#### MARGIN EXPANSION:

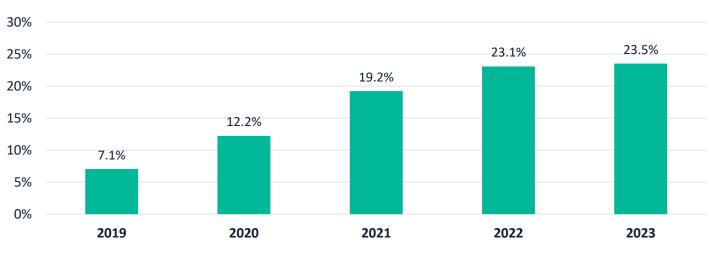
Improved mix shift to higher margin products driven by enhanced proprietary design and benefits

### Leverage on higher sales

Cost control initiatives designed to enhance margin performance



#### **OPERATING MARGIN**



# HISTORICAL FINANCIAL SUMMARY

### **EPS COMMENTARY:**

Improved mix shift to higher margin products driven by enhanced proprietary design and benefits

Leverage on higher sales

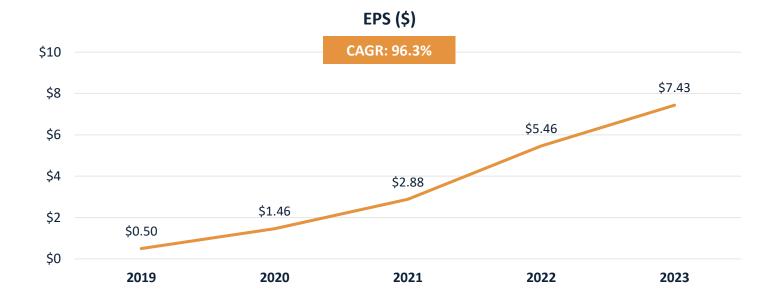
Cost control initiatives designed to enhance margin performance

Reduction in Diluted Shares of 3.8M

### CASH FLOW COMMENTARY:

Improved cash flow performance driven by profitability

Investments in technology and capacity to support long term growth expectations



FREE CASH FLOW (millions)



# LONG-TERM FINANCIAL MODEL

### **10% + Diluted EPS CAGR** 2023 to 2027

Other Key Assumptions

- Tax Rate of 15%
- Diluted Shares Outstanding of 32M
  - With potential for upside to share buyback assumption, guided by rate of return profile
- Target FCF\* Conversion of EBITDA\*\* of >75%

	2023 BASELINE	2027 TARGET MODEL
Revenue (\$M)	\$1.1B	~ \$1.6B
Gross Margin	43.5%	> 45%
Operating Margin	23.5%	> 27%
Tax Rate	11.6%	~ 15%
Diluted EPS	\$7.43	> \$11.50

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\* Free Cash Flow: Net cash provided by operating activities less Expenditures for property, plant and equipment and capitalized software

38 \*\*EBITDA: Earnings before Interest, Taxes, Depreciation & Amortization

# GROWTH IN REVENUE

### **CRITICAL REVENUE ASSUMPTION**

- Continued growth in mature markets including Power SiC and Si IGBT
- Recovery in memory spending
- Share gain in Advanced Logic
- Image Sensor recovery
- Increased contribution of Customer Success & Innovation (CS&I)



# CS&I: A GROWING PART OF OUR REVENUE MIX

#### What is CS&I?

Represents revenue derived from the sale of Consumables, Spares, Services and Upgrades

Examples of what we provide to current customers

- Consumables: Graphite Liners
- Service: Preventative Maintenance
- Spares: Robots, Sources, RF Generators
- Upgrades: Software Updates, Wafer Size Change Kits

A typical implanter's life is measured in decades (10-20 years) and provides us an annual revenue stream based on the utilization of our customers and device design changes they implement.

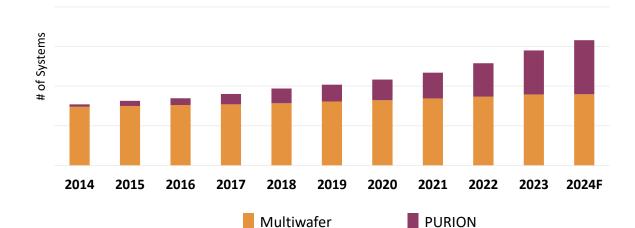
More than > 3,200 tools in our installed base:

- Purion
- Multiwafer Implanters
- Other Legacy Systems

#### **AXCELIS CS&I REVENUE - ALL INSTALLED TOOLS**



#### AXCELIS ION IMPLANT INSTALLED BASE



# OPERATING MARGIN EXPANSION

### >350 bps Expansion in Operating Margins

Revenue Mix

- Systems mix between HE, HC and MC
- Growth in CS&I

Incremental operating leverage more than offsetting anticipated investments

Cost controls

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# **OPERATING MARGIN** > 27.0% 23.5% 2023 Baseline 2027 Target

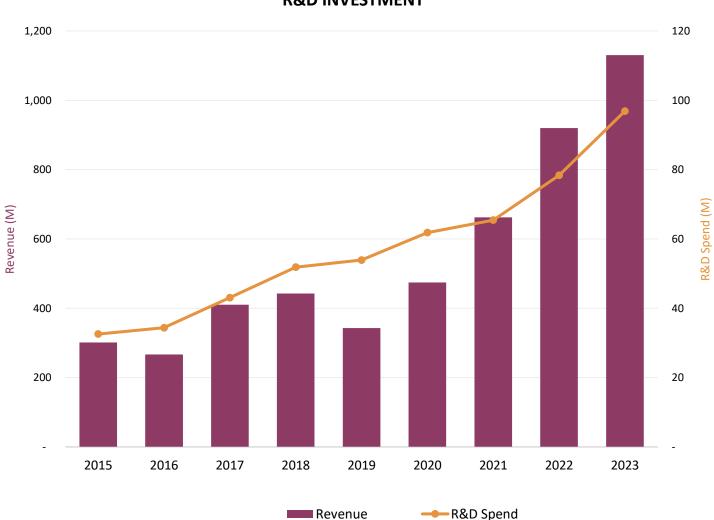
# CONTINUOUS INVESTMENT IN ION IMPLANT R&D

> \$100M Expected R&D Spending Annually On New Technologies, Products and Capabilities

Axcelis has heavily focused R&D spending on Purion product development

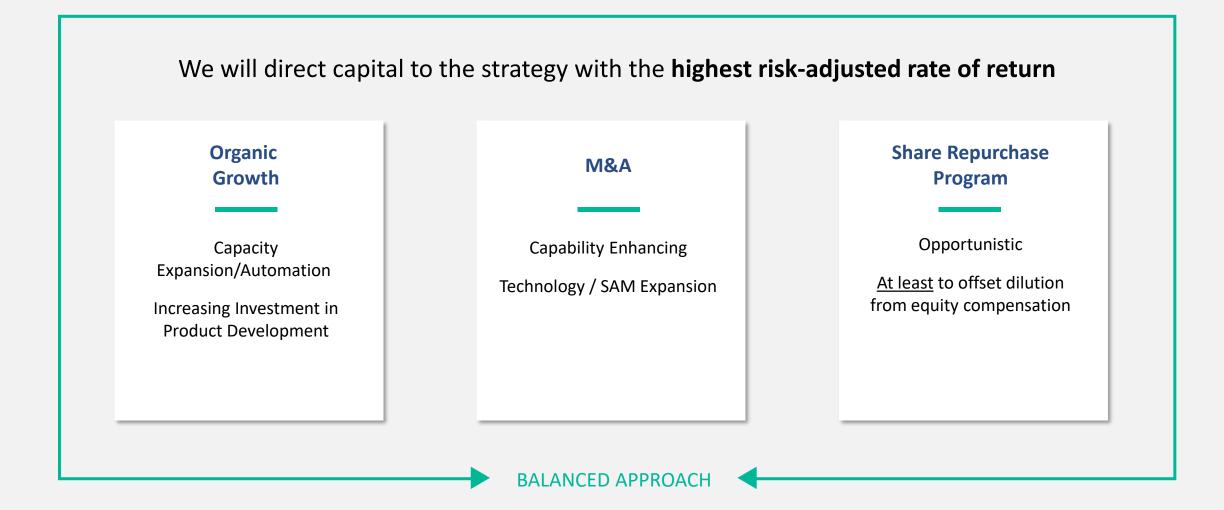
Many new products and extensions have been released and shipped to numerous first time and existing customers

We will continue to invest R&D dollars on new Purion product extensions, CIP, field upgrades and new technologies



#### **R&D INVESTMENT**

# CAPITAL ALLOCATION PHILOSOPHY





# **INVESTMENT CASE SUMMARY**



Foundational Technology for Semiconductor Manufacturing Well Positioned for Market Inflections & Secular Growth Opportunities

Long-Term Margin Expansion & Earnings Growth Strong Balance Sheet with Balanced Capital Allocation





